

# Heat flux tests of SiC-fibre reinforced Cu matrix composite

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IPP

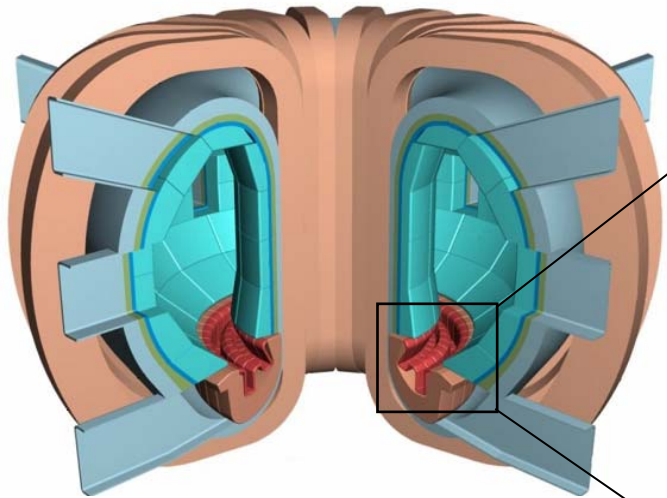
1. Requirements for DEMO

2. Processing of metal matrix composites (MMC)

3. GLADIS - High heat flux tests

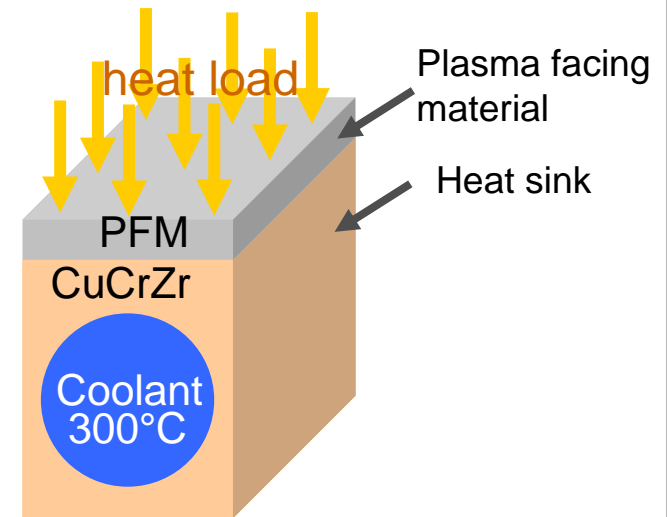
4. Microscopy analyses after heat flux tests

4. Summary



## DEMO - Divertor

Heat flux of 10-20 MW/m<sup>2</sup>



DEMO: demonstration reactor

- Deuterium-tritium plasma
- Fusion power 2000 MW

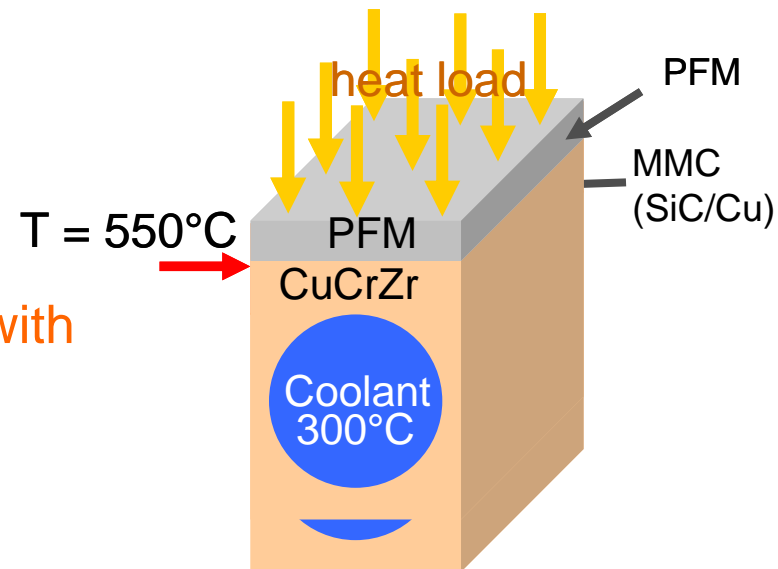


**Aim: High cooling temperature necessary for a high efficiency of future fusion reactors**

- High temperature ( $\sim 550^{\circ}\text{C}$ ) at the interface plasma facing material/heat sink
- Stresses due to different CTEs & temperature gradient at the W/CuCrZr interface

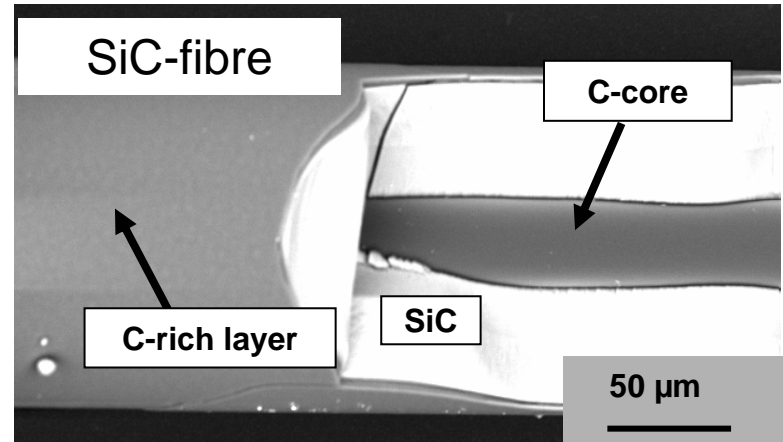
⇒ **MMC interlayer – Cu matrix reinforced with SiC fibres**

- High thermal conductivity  $\sim 200 \text{ W/mK}$
- Sufficient mechanical strength



## Fibre

- SCS6-Fibre (Specialty Materials)  
 $\varnothing = 140 \mu\text{m}$
- Carbon rich layer at the surface for protection during handling
- Developed for titanium matrix

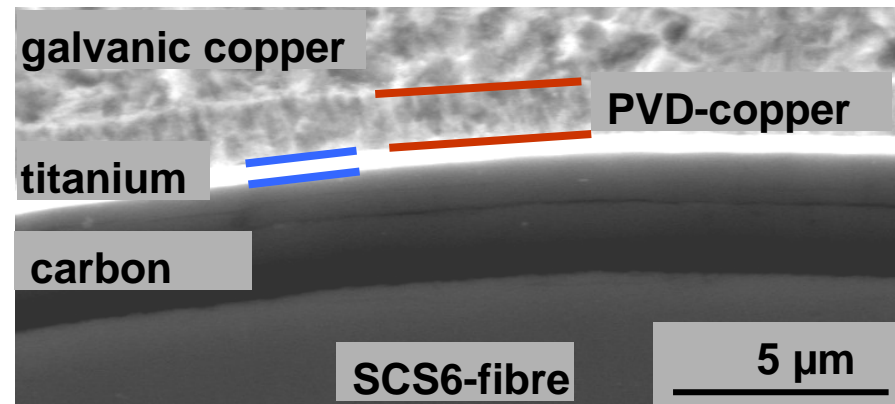


## Deposition – fibre matrix interface

Magnetron sputtering:

- Ti interlayer ( $\sim 200 \text{ nm}$ )
- Cu layer for protection ( $\sim 500 \text{ nm}$ )

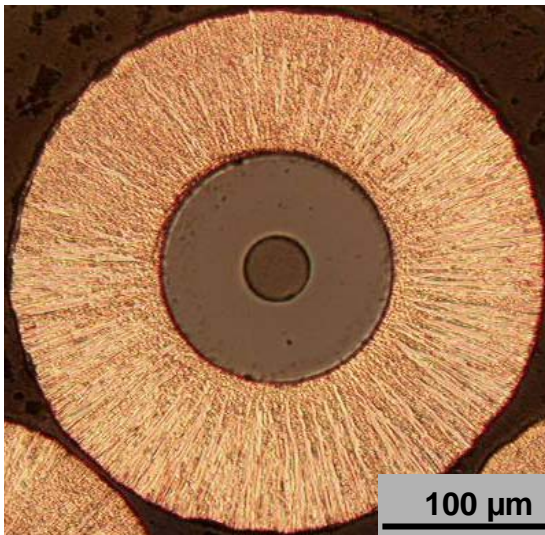
→ Good bonding fibre/matrix



## Deposition – Cu matrix

Electroplating of copper as matrix material in a  $\text{CuSO}_4$  bath at RT by two subsequent processes

1. Fibres coated for 1 h
2. Coated single fibres were fixed on a frame, coated for 10 h



**Deposition time defines Cu thickness → fibre volume fraction**

## Heat treatment

- Outgassing of hydrogen, slow heating rate of 20 K/h up to 550°C
- Reduction of porosity
- TiC formation

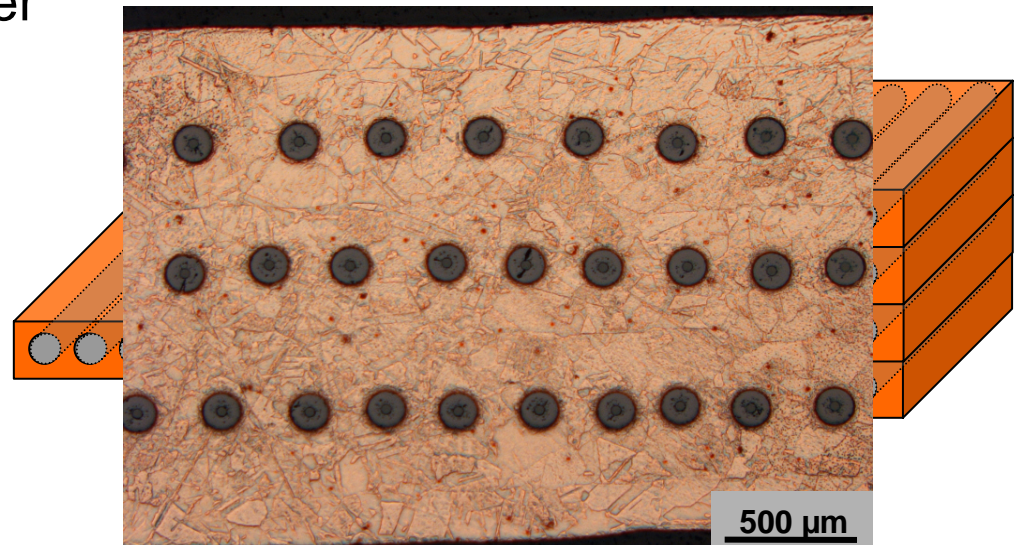
## Etching of UD single layers

Etching agent: phosphoric acid, nitric acid, acetic acid

→ Removing of oxide layer

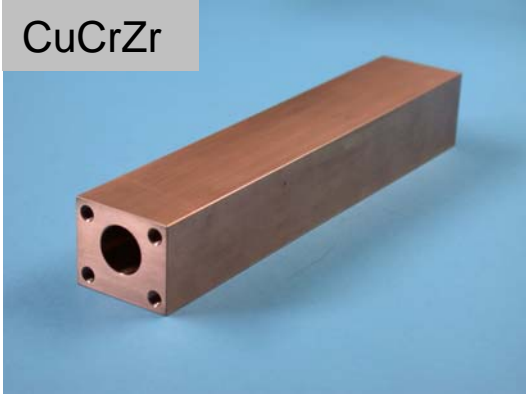
## Consolidation

Vacuum hot pressing to form the MMC specimens  
650°C (1h), ~40 MPa

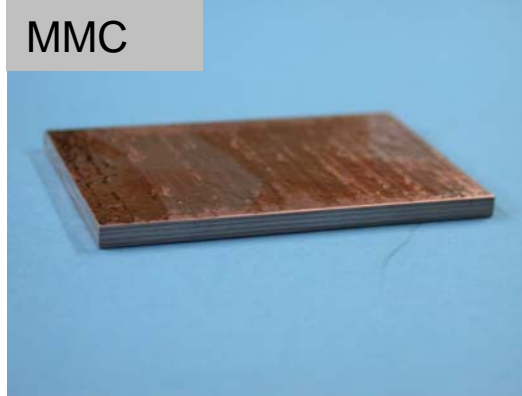


## Components of flat-tile mock-up

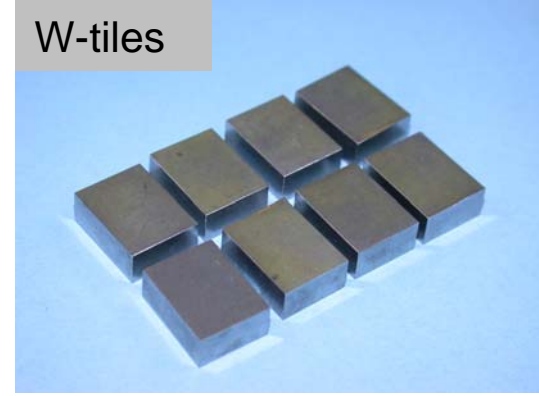
CuCrZr



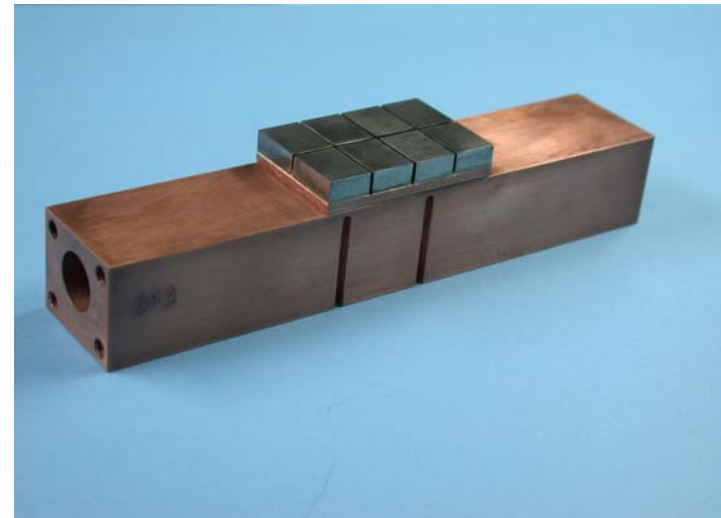
MMC



W-tiles

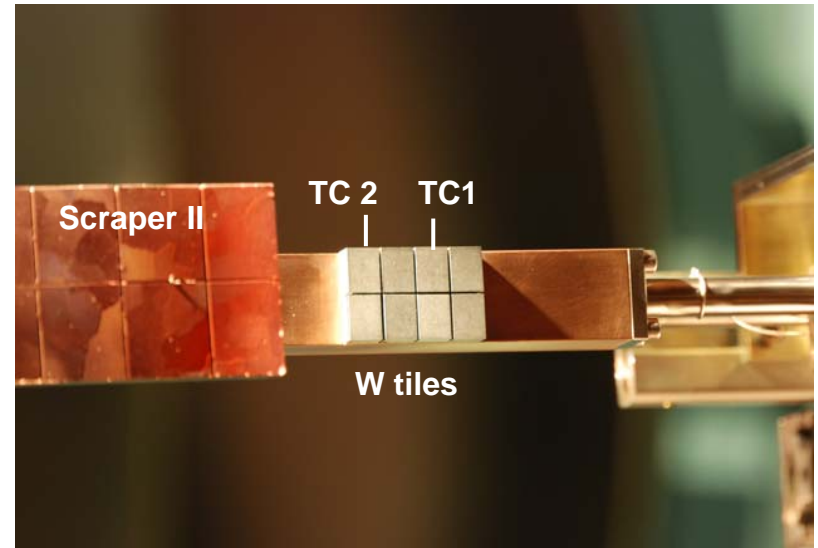
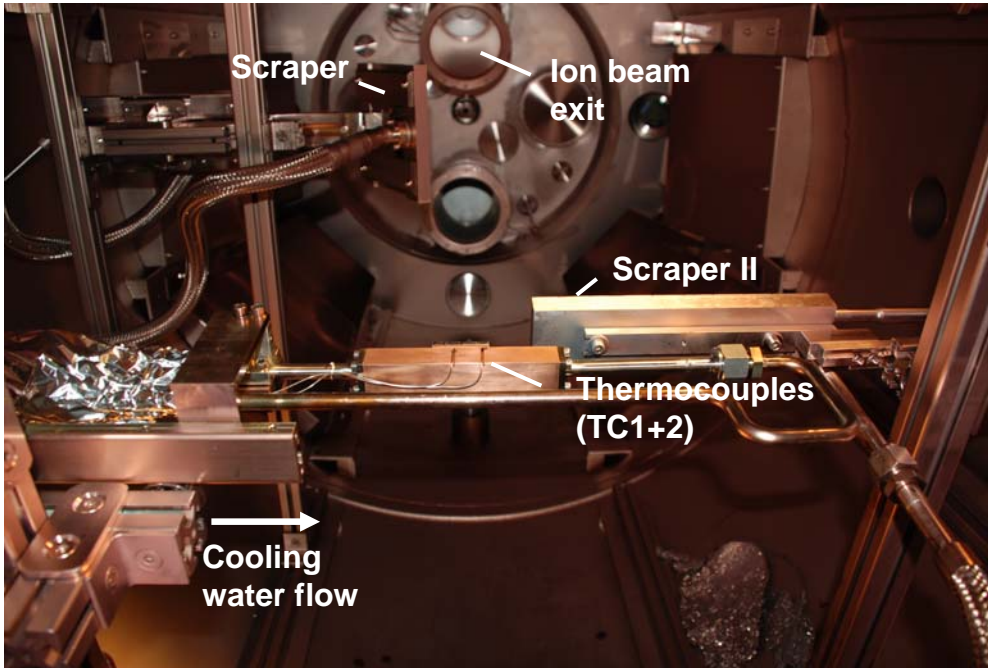


- CuCrZr
  - MMC interlayer (41,5x27x2,5mm<sup>3</sup>)  
 $v_f \sim 14\%$ , 4 or 5 layers, 0°/0°
  - 8 W tiles (10x13x5mm<sup>3</sup>)
- Brazing of components  
by Ansaldo (Gemco brazing foil)
- 3 flat-tile mock-ups



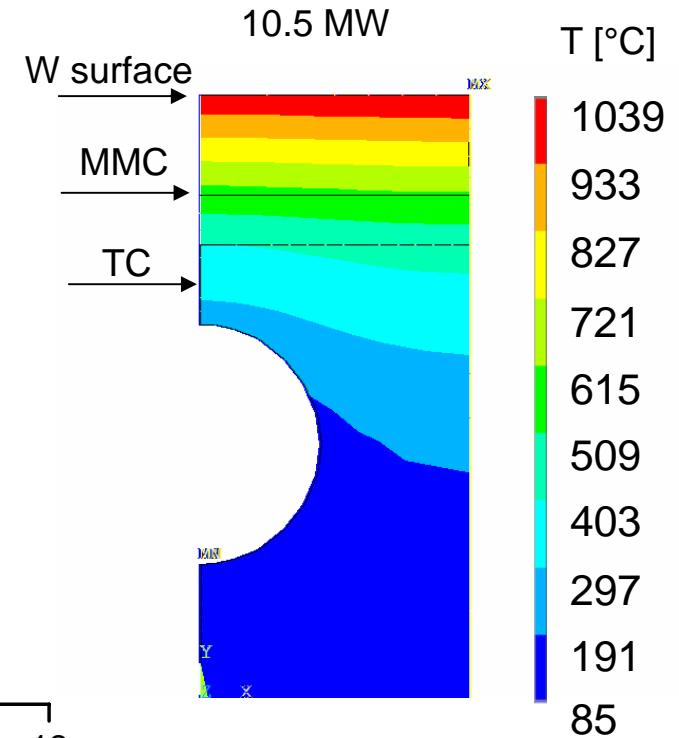
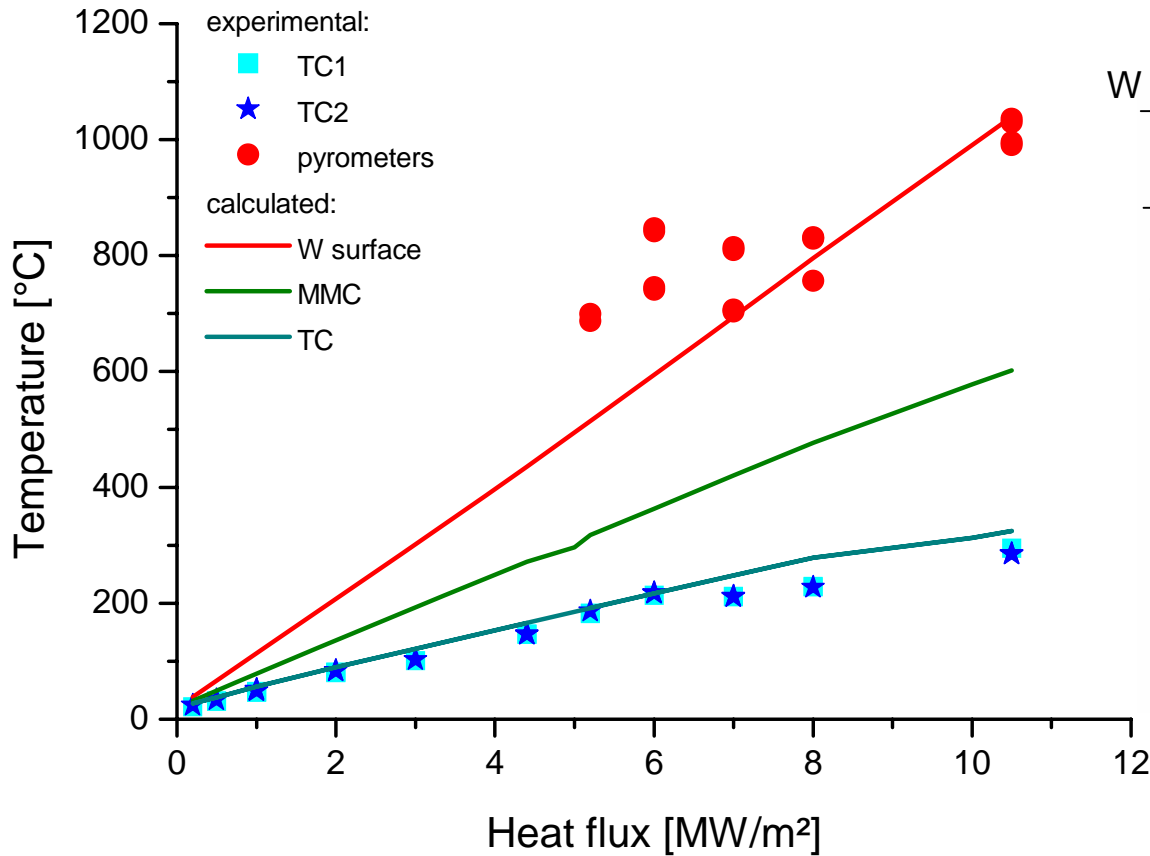


## GLADIS vacuum chamber



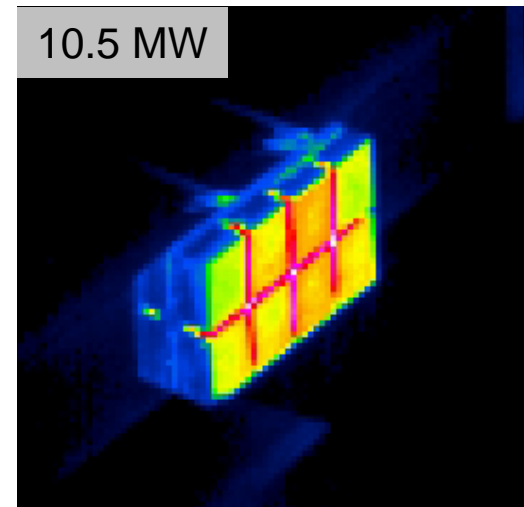
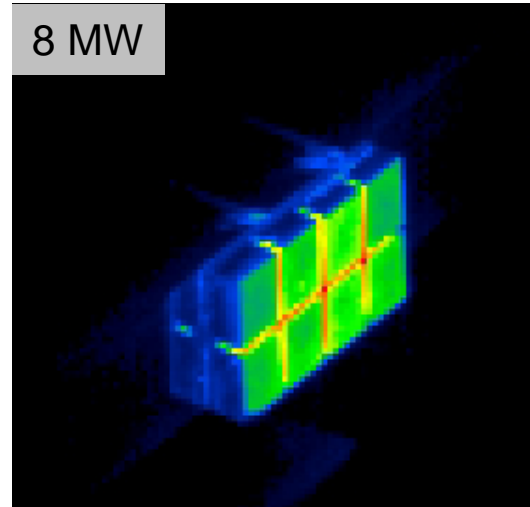
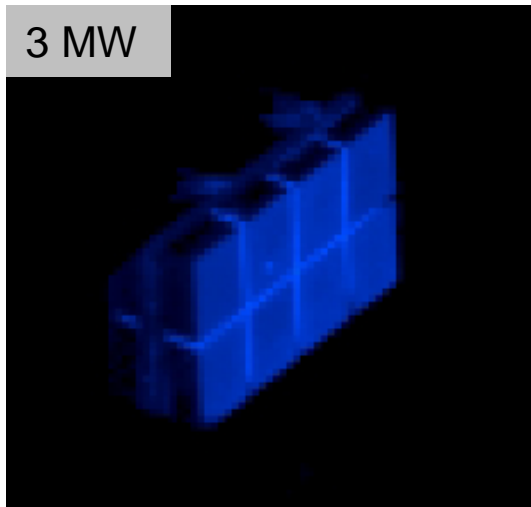
T-analysis: IR camera, pyrometers, thermocouples, CCD video camera

Heat flux tests: screening: 0.2 MW/m<sup>2</sup> - 10.5 MW/m<sup>2</sup> (30 s)  
cycling: 10.5 MW/m<sup>2</sup> (20-80 cycles, 20 s)

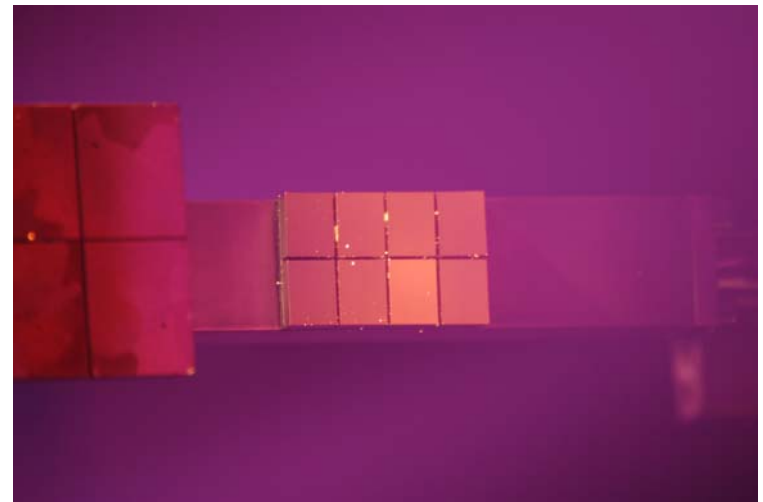


- Good correlation between measured and calculated temperatures
- Highest temperature at the W-surface at the edge of mock-up

## Screening mock-up 4: 0.2 – 10.5 MW/m<sup>2</sup>



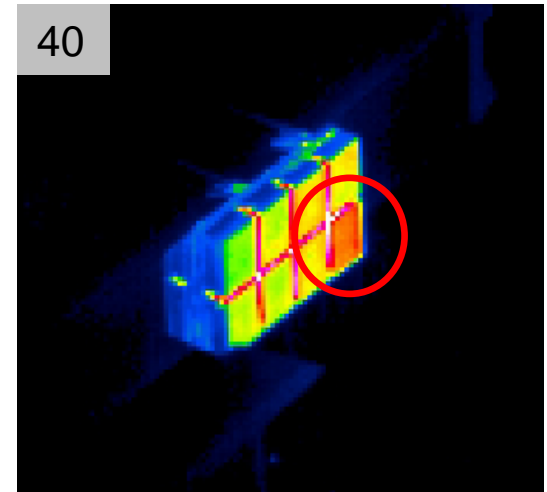
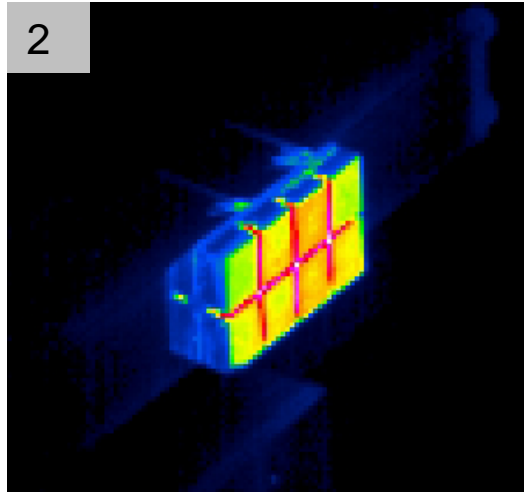
- Uniform temperature distribution
  - Fast and uniform cooling of W-tiles
  - No overheating of W-tiles
  - No damage visible
- Sufficient heat transport at 10.5 MW/m<sup>2</sup>



## Cycling mock-up 4: 10.5 MW/m<sup>2</sup>, 40 cycles + 40 cycles (6 W-tiles)

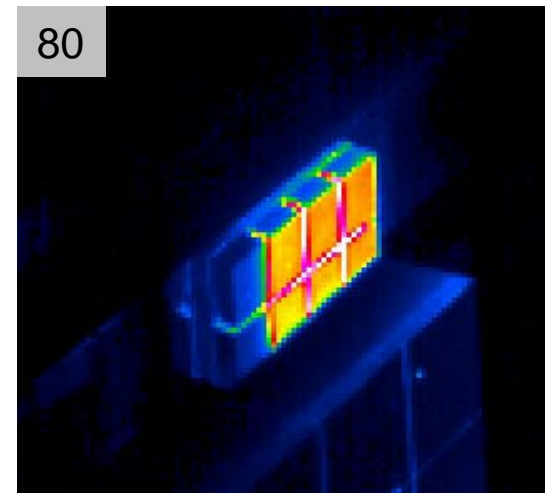
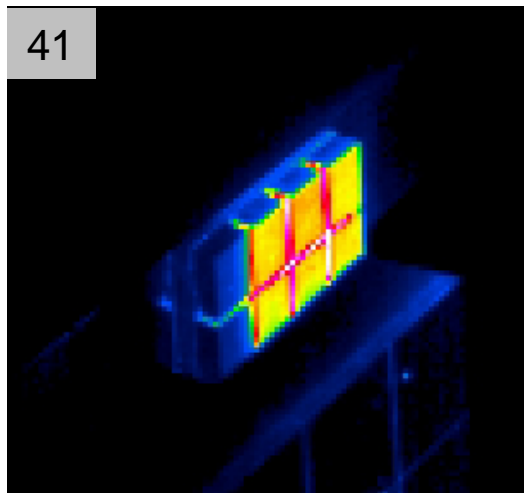
Overheating of  
one W-tile

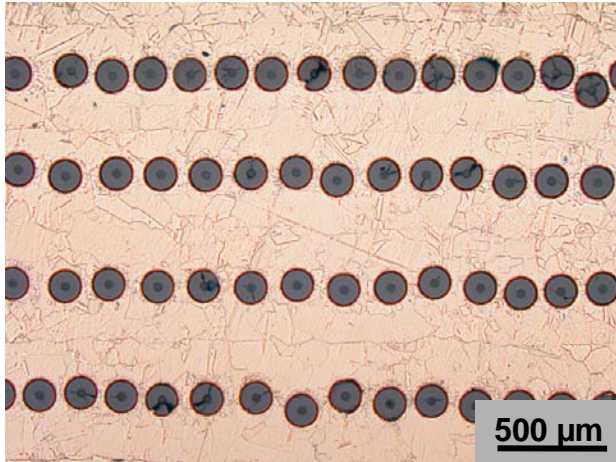
- Stop after 40 cycles
- Covering of  
damaged W-tile



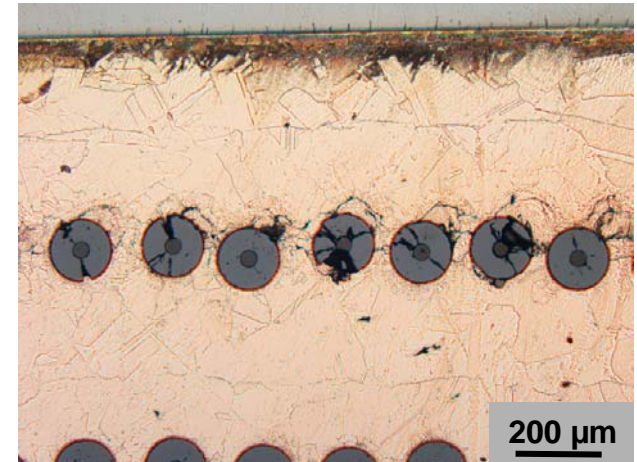
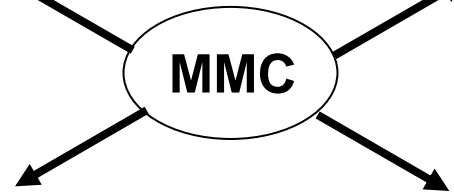
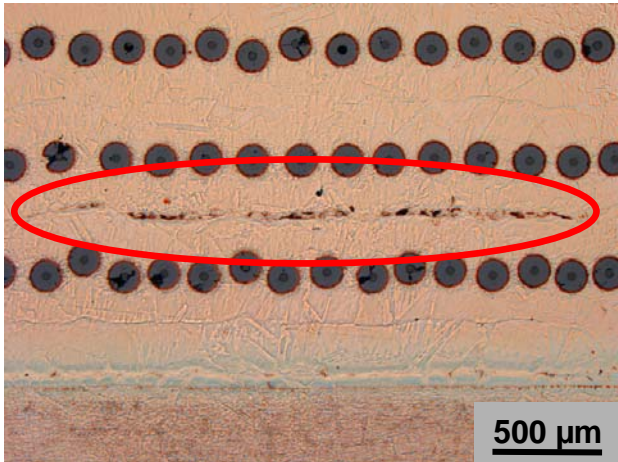
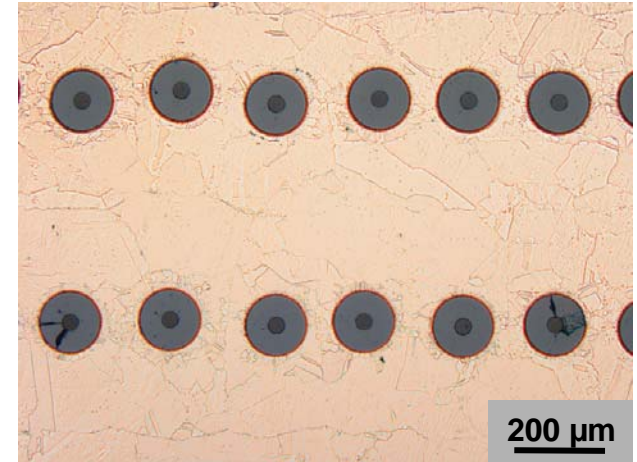
Continuous temperature  
rise at surface of W-tiles

- Stop after 80 cycles





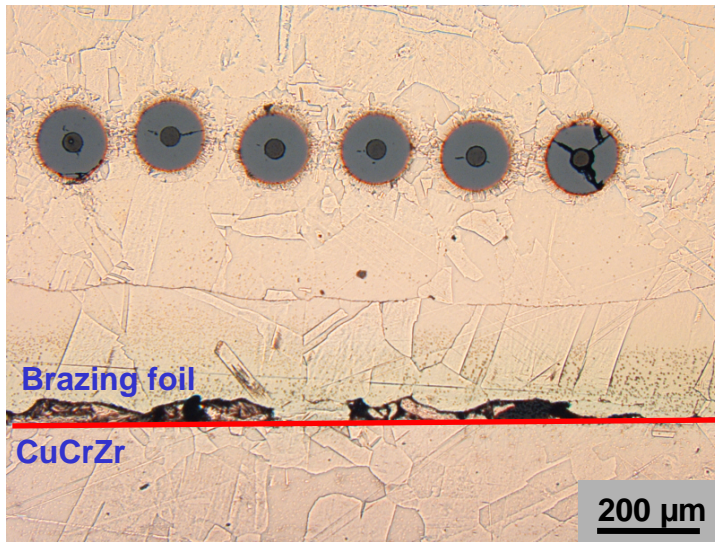
Good bonding  
between layers



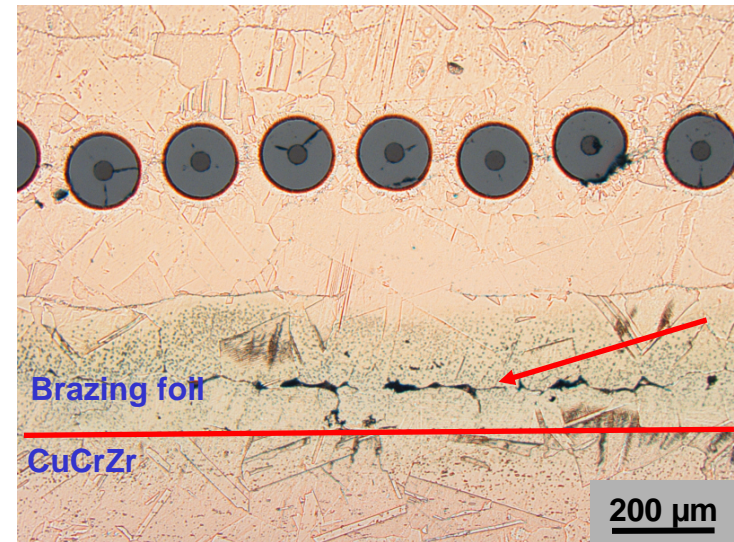
- Localized defects
- No crack growth

Small cracks within the  
matrix at outer fibre layers  
→ different CTE, stress

## Bonding MMC/CuCrZr and MMC/W



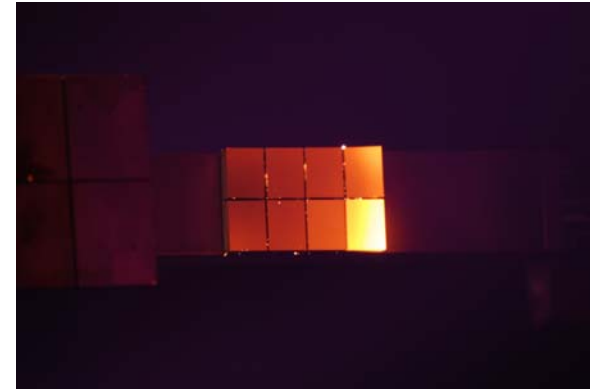
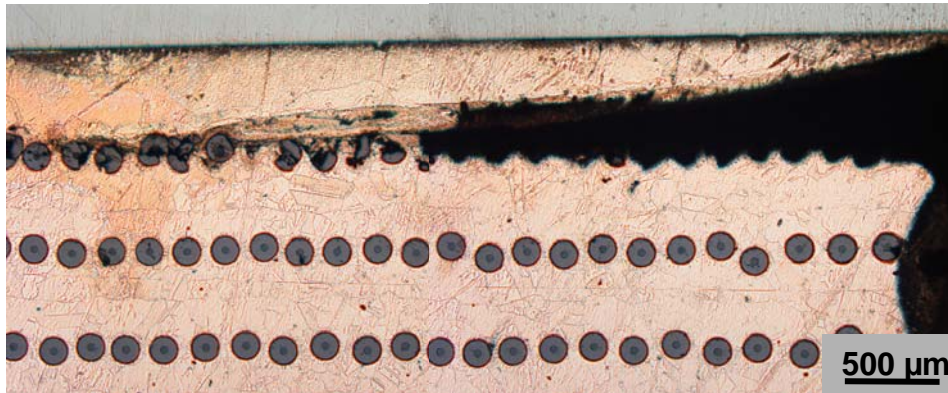
Cracks between brazing foil and CuCrZr/W



Cracks within the brazing foil (2 brazing foils used)

→ Bonding needs improvement

## Overheating of W-tile - cross section of the damage



Failure at the MMC edge

→ Insufficient heat flow, overheating of W-tile

Possible interaction of:

- Different CTE, stress concentration
- Highest temperature
- Weak points can lead to failure (bonding between brazing foil and W/MMC, cracks within brazing foil/MMC)

## Heat flux tests - 80 cycles at 10.5 MW/m<sup>2</sup>

### MMC:

- good bonding between the layers
  - single cracks, no crack extension visible
  - few matrix cracks at the outer layers due to stress
- **MMC behaviour promising**

### Component:

- Outer layers of MMC – different CTE, stress concentration, highest temperature
  - Interface/bonding between the components - brazing technology
- **Bonding is a weak point**



Thank you for your attention!